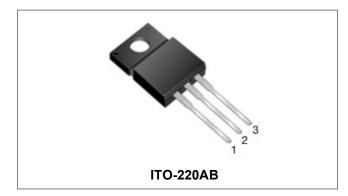


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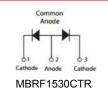


# **MBRF1530CT(CTR) SCHOTTKY RECTIFIER**



## **Circuit Diagram**





### **Features**

- 125°C T<sub>J</sub> operation
- Center tap configuration
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

### Applications

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

## Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	-	30	V
Average Rectified Forward Current	I <sub>F (AV)</sub>	50% duty cycle @Tc=80°C, rectangular wave form	7.5(Per Leg) 15(Per Device)	A
Peak One Cycle Non-Repetitive Surge Current(Per Leg)	I <sub>FSM</sub>	8.3ms, Half Sine pulse	156	А

## **Electrical Characteristics:**

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop(Per Leg)*	V <sub>F1</sub>	@ 7.5A, Pulse, TJ = 25 °C	0.45	0.50	V
	V <sub>F2</sub>	@ 7.5A, Pulse, T <sub>J</sub> = 125 °C	0.35	0.39	V
Reverse Current(Per Leg)*	I <sub>R1</sub>	$@V_R = rated V_{R,} T_J = 25 \ ^{\circ}C$	0.06	1	mA
	I <sub>R2</sub>	$@V_R = rated V_{R,} T_J = 125 \circ C$	40	58	mA
Junction Capacitance(Per Leg)	Ст	$C_T$ @V <sub>R</sub> = 5V, T <sub>C</sub> = 25 °C, f <sub>SIG</sub> = 1MHz		590	рF
Series Inductance(Per Leg)	Ls	Measured lead to lead 5 mm from package body	8.0	-	nH
Voltage Rate of Change	dv/dt	-	-	10,000	V/μs
RSM Isolation Voltage (t = 1.0 second, R. H. < =30%, $T_A = 25 \text{ °C}$ )	V <sub>ISO</sub>	Clip mounting, the epoxy body away from the heatsink edge by more than 0.110" along the lead direction.	-	4500	V
		Clip mounting, the epoxy body is inside the heatsink.	-	3500	
		Screw mounting, the epoxy body is inside the heatsink.	-	1500	

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**Typical Reverse Characteristics** 

RoHS

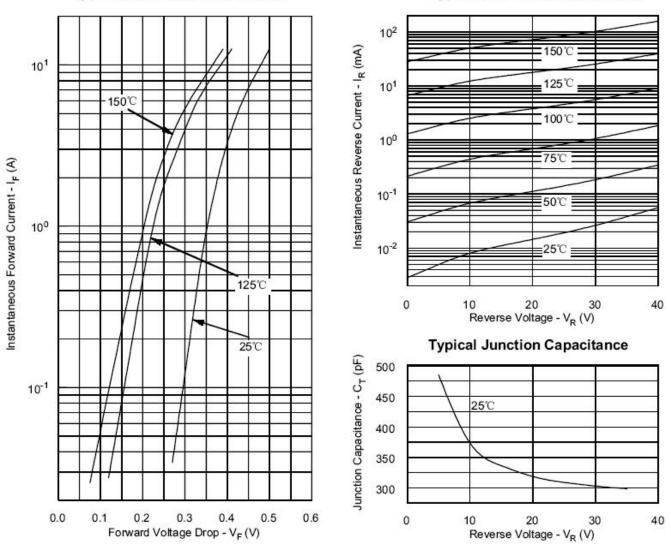
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\* Pulse width < 300  $\mu s, \ duty \ cycle < 2\%$ 

## **Thermal-Mechanical Specifications:**

Characteristics	Symbol Condition		Specification	Units
Junction Temperature	TJ	-	-55 to +125	°C
Storage Temperature	T <sub>stg</sub>	-	-55 to +150	°C
Typical Thermal Resistance Junction to Case(Per Leg)	$R_{ ext{ heta}JC}$	DC operation	3	°C/W
Approximate Weight	wt	-	2	g
Case Style	ITO-220AB			

## **Ratings and Characteristics Curves**



Typical Forward Characteristics

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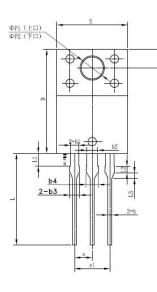


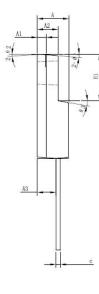
# RoHS 🗭

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## **Mechanical Dimensions ITO-220AB**

-

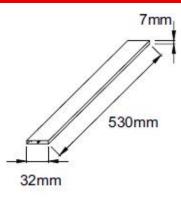




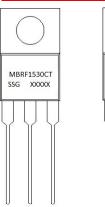
SYMBOL	Millimeters				
STMBOL	MIN.	TYP.	MAX.		
A	4.30	4.50	4.70		
A1	1.10	1.30	1.50		
A2	2.80	3.00	3.20		
A3	2.50	2.70	2.90		
b	0.50	0.60	0.75		
b1	1.10	1.20	1.35		
b2	1.50	1.60	1.75		
b3	1.20	1.30	1.45		
b4	1.60	1.70	1.85		
с	0.50	0.60	0.75		
D	14.80	15.00	15.20		
E	9.96	10.16	10.36		
e		2.55			
e1		5.10			
H1	6.50	6.70	6.90		
L	12.70	13.20	13.70		
L1	1.60	1.80	2.00		
L2	0.80	1.00	1.20		
L3	0.60	0.80	1.00		
<b>ΦΡ1</b> (上口)	3.30	3.50	3.70		
<b>ΦΡ2</b> (下口)	2.99	3.19	3.39		
Q	2.50	2.70	2.90		
Θ1		5°			
Θ2		4°			
Θ3		10°			
Θ4		5°			
Θ5		5°			

# 

## **Tube Specification**



## **Marking Diagram**



#### Where XXXXX is YYWWL

MBR

F

15

30

YY WW

L

SSG

MBRF1530CTR

XXXXX

SSG

- = Device Type
- = Package type = Forward Current (15A)
- = Reverse Voltage (30V)
- CT(CTR) = Configuration
  - = SSG
  - = Year = Week
  - = Lot Number
- Cautions: Molding resin Epoxy resin UL:94V-0

## **Ordering Information**

Device	Package	Shipping
MBRF1530CT(CTR)	ITO-220AB(Pb-Free)	50 pcs/ tube

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

- China Germany Korea Singapore United States
  - http://www.smc-diodes.com sales@ smc-diodes.com •



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